



### **RI-TRP-R9VS, RI-TRP-W9VS**

SCBS876-NOVEMBER 2008

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## MOUNT-ON-METAL TRANSPONDER

#### **FEATURES**

- Best in Class Performance Through Patented HDX Technology
- Patented Transponder Tuning Provides Stable and High Read/Write Performance
- 64-Bit Read-Only Memory (RI-TRP-R9VS) 80-Bit Read-Write Memory (RI-TRP-W9VS)
- Insensitive to Almost All Non-Metallic Materials

#### APPLICATIONS

- Waste Management
- Asset Management
- Container Tracking
- Vehicle Identification
- Access Control

#### DESCRIPTION

Texas Instruments mount-on-metal transponder provides superior performance and operates at a resonance frequency of 134.2 kHz. Texas Instruments LF transponders are manufactured with TI's patented tuning process to provide consistent read and write performance. Prior to delivery, the transponders undergo complete functional and parametric testing, in order to provide the high quality customers have come to expect from TI. The transponder is well suited for usage in a broad range of applications including, but not limited to, access control, vehicle identification, container tracking, asset management, and waste management applications.

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

#### NOTE:

For more information, contact the sales office or distributor nearest you. This contact information can be found on our web site at http://www.ti.com/rfid.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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#### **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)

	RI-TRP-R9VS, RI-TRP-W9VS		
Operating Temperature	25 to 70°C		
Storage Temperature	–25 to 85°C		

#### **OPERATING CHARACTERISTICS**

over operating free-air temperature range (unless otherwise noted)

	RI-TRP-R9VS	RI-TRP-W9VS			
Functionality	Read only	Read/write			
Memory (Bits)	64	80			
Memory (Pages)	1 1				
Operating Frequency	134.2 kHz				
Modulation	FSK (frequency shift keying) 134.2 kHz / 123.2 kHz				
Transmission Principle	HDX (half duplex)				
Power Source	Powered from the reader signal				
Typical Reading Range	≤120 cm <sup>(1)</sup>				
Typical Programming Range	_	30% of typical reading range			
Typical Reading Time	70 ms				
Typical Programming Time	_	309 ms			
Typical Programming Cycles	_	100,000			
Case Material	Polypropylene, black				
Protection Class	IP 67				
Mounting	With screws or rivets on aluminum, iron, or steel				
EMC	Programmed code is not affected by normal electromagnetic interference or X-rays				
Signal Penetration	Transponder can be read through virtually all non-metallic material				
Mechanical Shock	IEC 68-2-27, Test Ea; 200 g, half sine, 3 ms, 3 axes, 6 shocks per axis				
Vibration	IEC 68-2-6, Test Fc; 20 g, 20 - 500 Hz, 3 axes, 10 cycles per axis				
Dimensions	102 mm ± 1 mm × 36 mm ± 1 mm × 16.5 mm ± 1 mm				
Weight	43 g				

(1) Depending on RF regulation in country of use, the reader antenna configuration used, and the environmental conditions.

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#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
RI-TRP-R9VS-30	ACTIVE	RFIDP	TEJ	0	50	Pb-Free (RoHS)	Call TI	N / A for Pkg Type
RI-TRP-W9VS-30	ACTIVE	RFIDP	TEJ	0	50	Pb-Free (RoHS)	Call TI	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

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**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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